MA3X721 (MA721)

Silicon epitaxial planar type

For super high speed switching For small current rectification

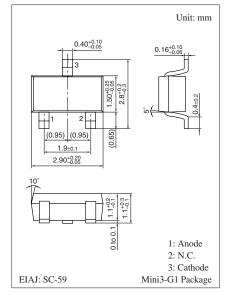
Features

• Forward current (Average) $I_{F(AV)} = 200$ mA rectification is possible

| 3 " | | | | | | |
|---|------------------|-------------|------|--|--|--|
| Parameter | Symbol | Rating | Unit | | | |
| Reverse voltage | V _R | 30 | V | | | |
| Maximum peak reverse voltage | V _{RM} | 30 | V | | | |
| Forward current | I_F | 200 | mA | | | |
| Peak forward current | I _{FM} | 300 | mA | | | |
| Non-repetitive peak forward surge current * | I _{FSM} | 1 | А | | | |
| Junction temperature | Tj | 150 | °C | | | |
| Storage temperature | T _{stg} | -55 to +150 | °C | | | |
| | | | | | | |

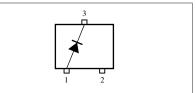
Absolute Maximum Ratings $T_a = 25^{\circ}C$

Note) *: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)



Marking Symbol: M1M

Internal Connection



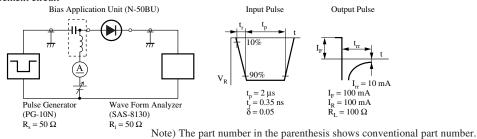
Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|-------------------------|-----------------|--|-----|-----|------|------|
| Forward voltage | V _F | $I_F = 200 \text{ mA}$ | | | 0.55 | V |
| Reverse current | I _R | $V_R = 30 V$ | | | 50 | μΑ |
| Terminal capacitance | Ct | $V_R = 0 V, f = 1 MHz$ | | 30 | | pF |
| Reverse recovery time * | t _{rr} | $I_F = I_R = 100 \text{ mA}$ | | 3.0 | | ns |
| | | $I_{rr} = 10 \text{ mA}, R_L = 100 \Omega$ | | | | |

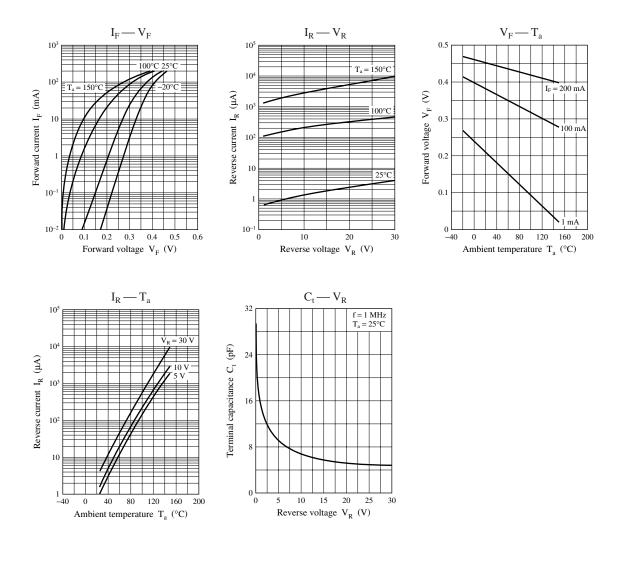
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

- 3. Absolute frequency of input and output is 1 GHz.
- 4. *: trr measurement circuit



Panasonic



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